

1.6X1.25mm BI-COLOR SMD CHIP LED LAMP

Part Number: APTB1612ESGC-F01

High Efficiency Red Super Bright Green

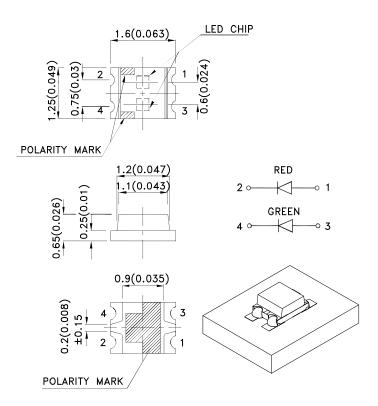
Features

- 1.6mmx1.25mm SMT LED, 0.65mm thickness.
- Bi-color,low power consumption.
- Wide viewing angle.
- Ideal for backlight and indicator.
- Package: 2000pcs / reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

Descriptions

- The High Efficiency Red source color devices are made with Gallium Arsenide Phosphide on Gallium Phosphide Orange Light Emitting Diode.
- The Super Bright Green source color devices are made with Gallium Phosphide Green Light Emitting Diode.

Package Dimensions



Notes:

- 1. All dimensions are in millimeters (inches).
 2. Tolerance is ±0.2(0.008") unless otherwise noted.
- 3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.

4. The device has a single mounting surface. The device must be mounted according to the specifications.

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Selection Guide

Part No.	Dice	Lens Type	lv (mcd) [2] @ 20mA		Viewing Angle [1]
			Min.	Тур.	201/2
APTB1612ESGC-F01	High Efficiency Red (GaAsP/GaP)	Water Clear	8	15	120°
			*3	*7	
	Super Bright Green (GaP)		5	12	
			*5	*12	

Notes:

- 1.01/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
 2.Luminous intensity/ luminous Flux: +/-15%.
 *Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	High Efficiency Red Super Bright Green	627 565		nm	IF=20mA
λD [1]	Dominant Wavelength	High Efficiency Red Super Bright Green	617 568		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	High Efficiency Red Super Bright Green	45 30		nm	IF=20mA
С	Capacitance	High Efficiency Red Super Bright Green	15 15		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	High Efficiency Red Super Bright Green	2 2.2	2.5 2.5	V	IF=20mA
lR	Reverse Current	High Efficiency Red Super Bright Green		10 10	uA	V _R = 5V

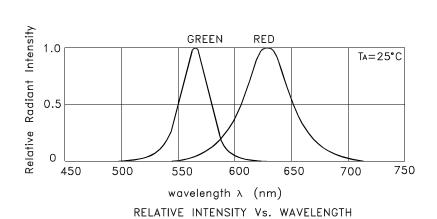
- Notes: 1.Wavelength: +/-1nm. 2.Forward Voltage: +/-0.1V.
- 3. Wavelength value is traceable to the CIE127-2007 compliant national standards.
- 4. Excess driving current and/or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

Absolute Maximum Ratings at TA=25°C

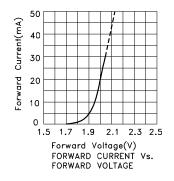
Parameter	High Efficiency Red	Super Bright Green	Units		
Power dissipation	75	62.5	mW		
DC Forward Current	30	25	mA		
Peak Forward Current [1]	160	140	mA		
Reverse Voltage	!	V			
Operating Temperature	-40°C To +85°C				
Storage Temperature	-40°C To +85°C				

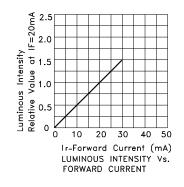
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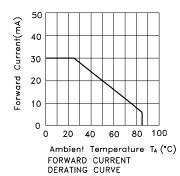
^{1. 1/10} Duty Cycle, 0.1ms Pulse Width.

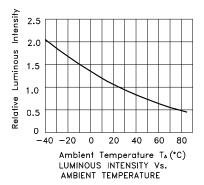


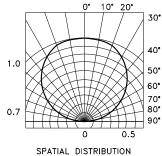
APTB1612ESGC-F01 High Efficiency Red





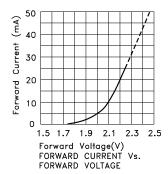


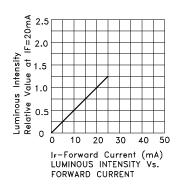


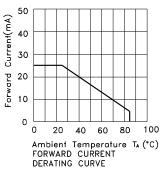


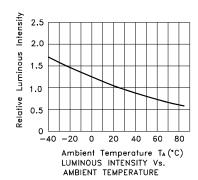
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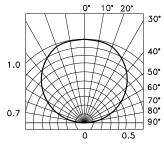
Super Bright Green











SPATIAL DISTRIBUTION

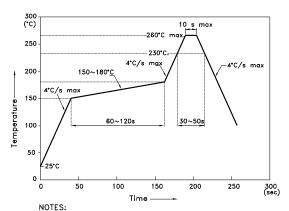
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Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



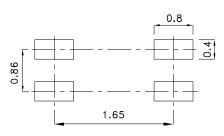
- NOTES:

 1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.

 2.Don't cause stress to the epoxy resin while it is exposed to high temperature. to high temperature.

 3.Number of reflow process shall be 2 times or less.

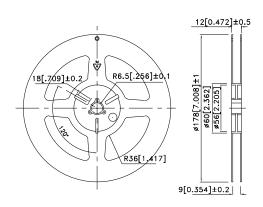
Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)

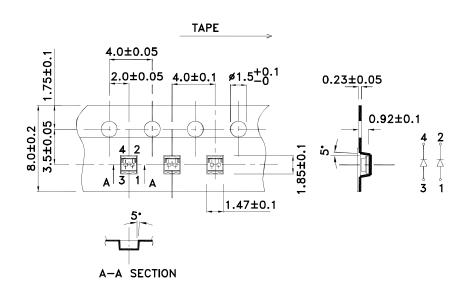


Tape Dimensions

(Units: mm)

Reel Dimension





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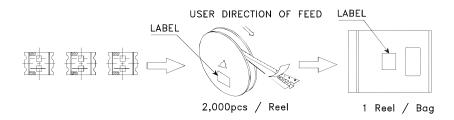
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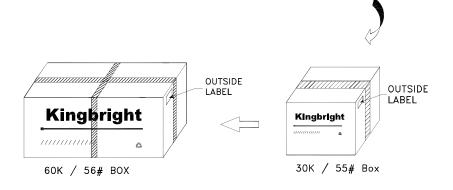
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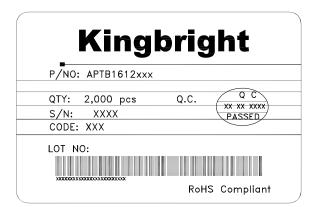
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PACKING & LABEL SPECIFICATIONS

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